

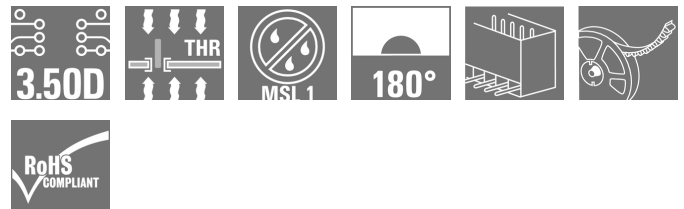
S2L-SMT 3.50/16/180G 3.5SN BK RL**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

Similar to illustration

High-temperature-resistant, double-row pin header for all common soldering methods. Optimised for automatic assembly. Packed in box or tape. Solder pin 3.2 mm long, suitable for reflow and wave soldering. The male connectors provide space for labelling and can be coded.

General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, Number of poles: 16, 180°, Solder pin length (l): 3.5 mm, tinned, black, Tape
Order No.	1807830000
Type	S2L-SMT 3.50/16/180G 3.5SN BK RL
GTIN (EAN)	4032248279531
Qty.	175 pc(s).
Product data	IEC: 160 V / 10 A UL: 150 V / 10 A
Packaging	Tape

Creation date September 16, 2022 12:08:17 PM CEST

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Technical data**Dimensions and weights**

Depth	10.8 mm	Depth (inches)	0.425 inch
Height	14.3 mm	Height (inches)	0.563 inch
Height of lowest version	14.2 mm	Width	29.4 mm
Width (inches)	1.157 inch	Net weight	6.52 g

System specifications

Product family	OMNIMATE Signal - series B2L/S2L 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	180°
Number of poles	16	Number of solder pins per pole	1
Solder pin length (l)	3.5 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D) +	0,1 mm
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	24.5 mm	L1 in inches	0.965 inch
Number of rows	2	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	Safe from back-of-hand touch	Touch-safe protection acc. to DIN VDE 0470	IP 10
Can be coded	Yes	Plugging force/pole, max.	3 N
Pulling force/pole, max.	6 N		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface	tinned	Layer structure of solder connection	2...3 µm Ni / 5...7 µm Sn glossy
Layer structure of plug contact	2...5 µm Sn / 1...3 µm Ni	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	10 A
Rated current, max. number of poles (Tu=20°C)	10 A	Rated current, min. number of poles (Tu=40°C)	9 A
Rated current, max. number of poles (Tu=40°C)	8.5 A	Rated voltage for surge voltage class / pollution degree II/2	160 V
Rated voltage for surge voltage class / pollution degree III/2	125 V	Rated voltage for surge voltage class / pollution degree III/3	50 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	1.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	1.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 77 A

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Technical data
Rated data acc. to CSA

Institute (CSA)



Certificate No. (CSA)

200039-1176845

Rated voltage (Use group B / CSA)	50 V
Rated voltage (Use group D / CSA)	150 V
Rated current (Use group C / CSA)	9.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.

Rated voltage (Use group C / CSA)	50 V
Rated current (Use group B / CSA)	5 A
Rated current (Use group D / CSA)	9.5 A

Packing

Packaging	Tape	VPE length	330 mm
VPE width	330 mm	VPE height	50 mm
Tape depth (T2)	19.8 mm	Tape width (W)	44 mm
Tape pocket depth (K0)	19.3 mm	Tape pocket height (A0)	11.1 mm
Tape pocket width (B0)	33.3 mm	Tape pocket separation (P1)	20 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	20.2 mm
Tape reel diameter $\varnothing$ (A)	330 mm	Surface resistance	$R_s = 10^9 - 10^{12} \Omega$
Width Pick & Place Pad (W_{PPP})	10 mm	Length Pick & Place Pad (L_{PPP})	15.6 mm
Diameter of the withdrawal surface ($\varnothing D_{max}$)	9 mm	Protrusion 1 Pick & Place Pad ($L_{01 (PPP)}$)	7.8 mm
Protrusion 2 Pick & Place Pad ($P_{02 (PPP)}$)	7.8 mm		

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Additional variants on request • Gold-plated contact surfaces on request • Spacing between rows: see hole layout • Rated current related to rated cross-section & min. No. of poles. • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

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Technical data**Approvals**

Approvals



ROHS Conform

UL File Number Search UL Website

Certificate No. (UR) E60693

DownloadsApproval/Certificate/Document of
Conformity[Declaration of the Manufacturer](#)

Product Change Notification

[PCN_2015_208_PL30X_SC-SMT_SL_SMT_3.xx_5.xx_new_Tape_Packaging_Step_2_EN](#)
[PCN_2015_208_PL30X_SC-SMT_SL_SMT_3.xx_5.xx_neue_Tapeverpackung_Step_2_DE](#)

Catalogues

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Brochures

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White paper surface mount technology

[Download Whitepaper](#)

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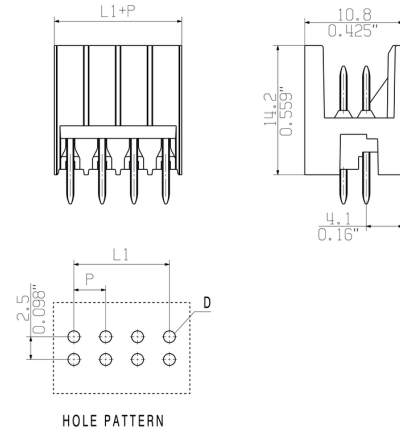
Drawings

Product image

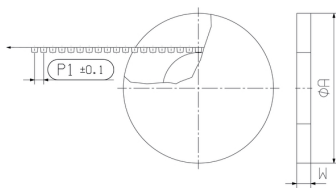


Similar to illustration

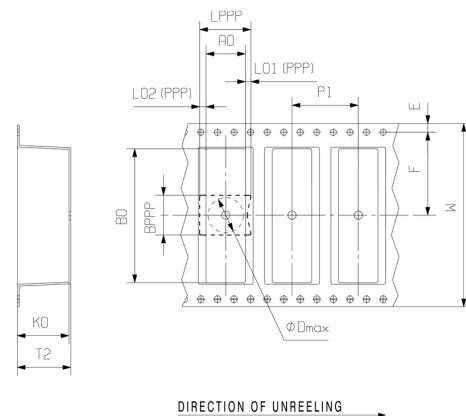
Dimensional drawing



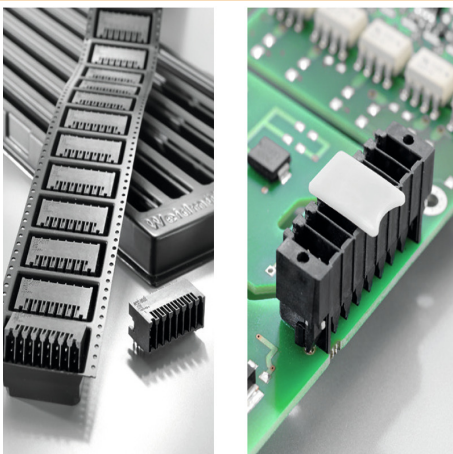
Dimensional drawing



Dimensional drawing



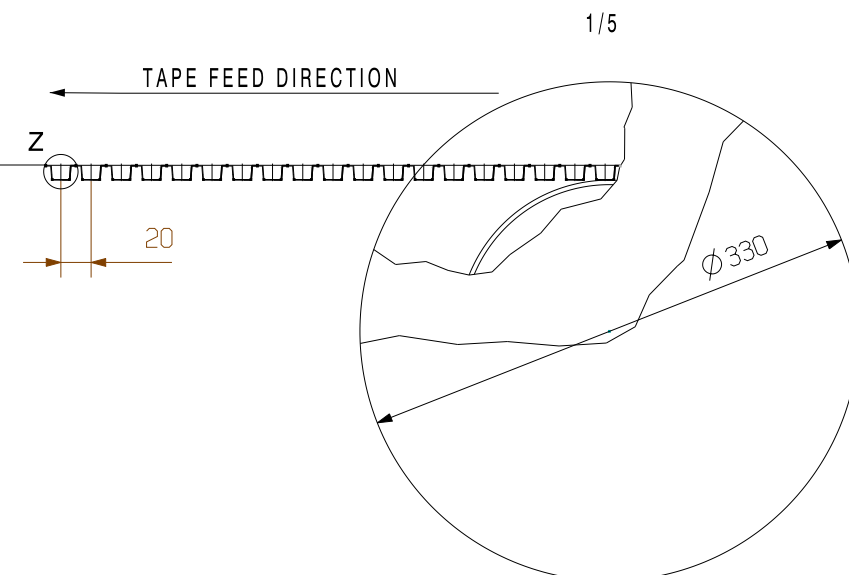
Product benefits



Optimised for the SMT process
Safe board-to-board connection

DIE DEUTSCHE VERSION IST VERBINDLICH
THE GERMAN VERSION IS BINDING

(C) WEIDMUELLER INTERFACE GmbH & Co. KG



NO OF POLES MATCHING IN TAPE														
OPEN ENDED					CLOSED ENDED					SOLDER FLANGE ENDED				
W					W					W				
32mm	44mm	56mm	72mm	88mm	32mm	44mm	56mm	72mm	88mm	32mm	44mm	56mm	72mm	88mm
4					4					4				
6					6					6				
8					8						8			
10						10					10			
	12					12					12			
	14					14					14			
	16					16						16		
	18						18					18		
		20					20					20		
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			26					26					26	
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				34					34					34
				36					36					36
				38					38					
				40										

		83816/5 03.09.15 AMANN_A 00		CAT.NO.: . C 33278 12	
MODIFICATION		Weidmüller 		DRAWING NO. SHEET 01 ISSUE NO. OF 02 SHEETS	
		DATE NAME		TAPE S2L-SMT 3.50/./180 TAPE STIFTFLEISTE TAPE PIN HEADER	
DRAWN 23.08.2007		LANG_T			
RESPONSIBLE		AMANN_A			
CHECKED 03.09.2015		HELIS_MA			
SCALE: 1/1		APPROVED		LANG_T	
SUPERSEDES: .		PRODUCT FILE: S2L-SMT 3.50		7272	

Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
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Germany
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Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.